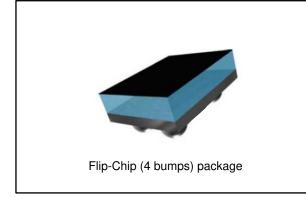


BALF-NRG-01D3

50 ohm nominal input / conjugate match balun balun to BlueNRG tranceiver, with integrated harmonic filter

Datasheet - production data



Features

- 50 Ω nominal input / conjugate match to BlueNRG device
- Low insertion loss
- Low amplitude imbalance
- Low phase imbalance
- Wafer level chip scale package (WLCSP)

Benefits

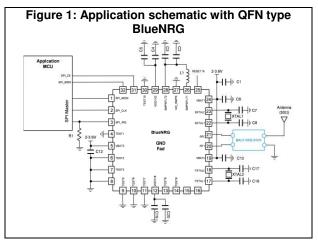
- Very low profile < 670 μm
- High RF performance
- RF BOM reduction
- Small footprint

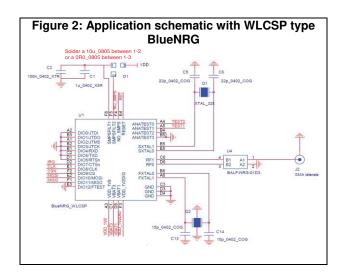
Applications

- Bluetooth low energy impedance matched balun filter
- Optimized for ST BlueNRG RFIC

Description

STMicroelectronics BALF-NRG-01D3 is an ultra miniature balun. The BALF-NRG-01D3 integrates matching network and harmonics filter. Matching impedance has been customized for the BlueNRG ST transceiver (both QFN and WLCSP versions). It is using STMicroelectronics IPD technology on non conductive glass substrate which optimizes RF performance.





May 2017

DocID026543 Rev 5

This is information on a product in full production.

1 Characteristics

Symbol	Parameter		Value	Value	
	Parameter	Min.	Тур.	Max.	Unit
Pin	Input power RFIN		-	20	dBm
N	ESD ratings MIL STD883C (HBM: C = 100 pF, R = 1.5 Ω , air discharge)		-		V
V _{ESD}	ESD ratings machine model (MM: C = 200 pF, R = 25 W, L = 500 nH)	200	-		
T _{OP}	Operating temperature	-40	-	+105	°C

Table 1: Absolute maximum ratings (limiting values)

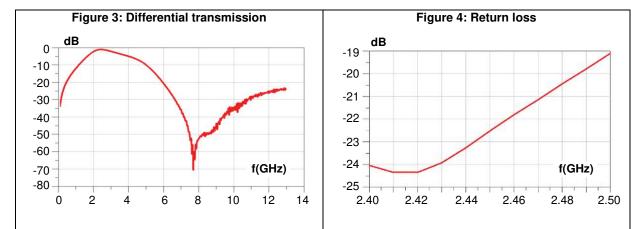
Table 2: Impedances (T_{amb} = 25 °C)

Symbol	Poromotor		Value			
Symbol	Parameter	Min.	Тур.	Max.	Unit	
Z _{OUT}	Nominal differential output impedance	-	Match to BlueNRG	-	Ω	
ZIN	Nominal input impedance	-	50	-	Ω	

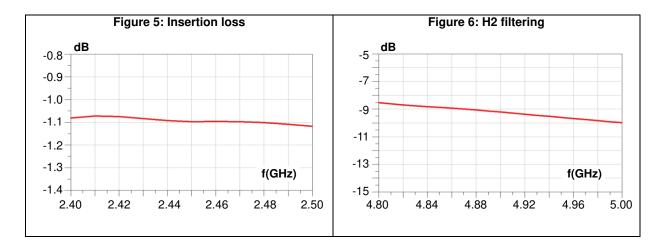
Table 3: RF performance (T_{amb} = 25 °C)

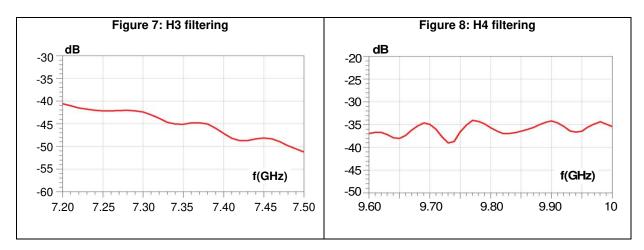
Symbol	Parameter	Test condition	Value			Unit	
Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit	
f	Frequency range (bandwidth)		2400		2500	MHz	
S11	Input return loss bandwidth			-20		dB	
S ₂₁	Insertion loss			-1.1		dB	
S21		H2		-8		dD	
		H3		-38			
	Harmonic rejection (differential mode)	H4		-31	dB		
		H5		-23			
ф imb	Output phase imbalance			7		0	
A _{imb}	Output amplitude imbalance			0.5		dB	





1.1 **RF** measurement

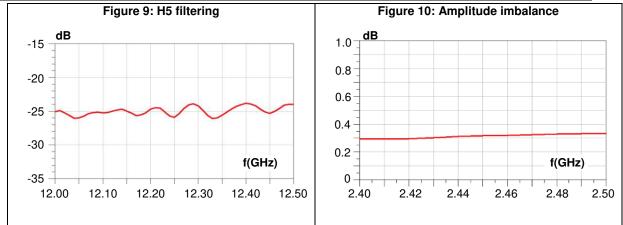


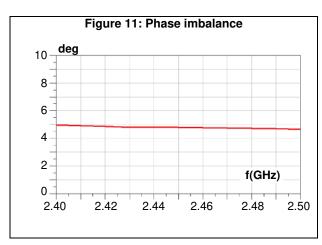


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Characteristics

BALF-NRG-01D3







2

BALF-NRG-01D3 with QFN type BlueNRG

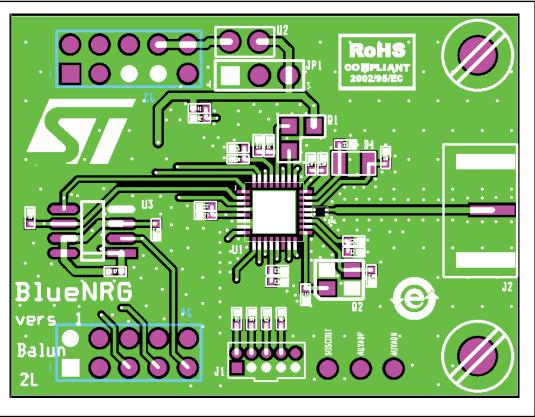
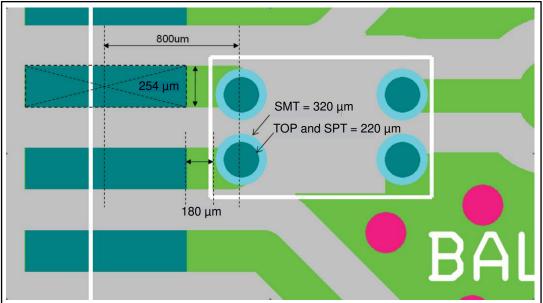


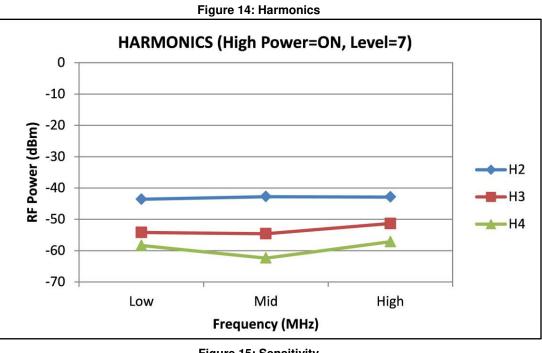
Figure 12: Application board EVB (2 layers)

Figure 13: Recommended balun land pattern (EVB)





BALF-NRG-01D3 measurements on QFN EVB 2.1



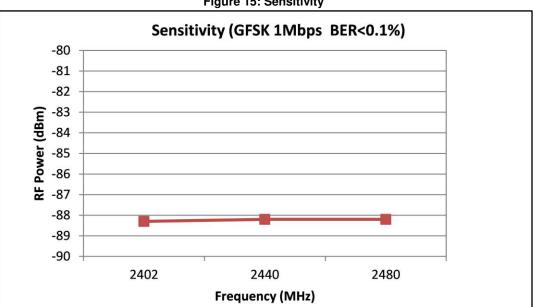
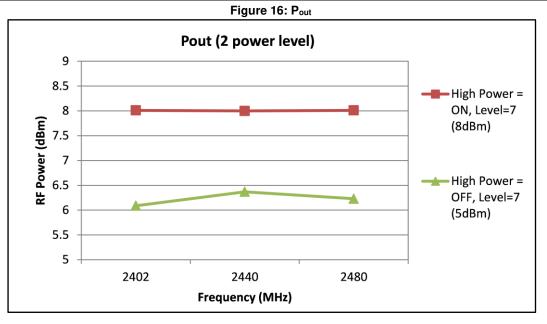


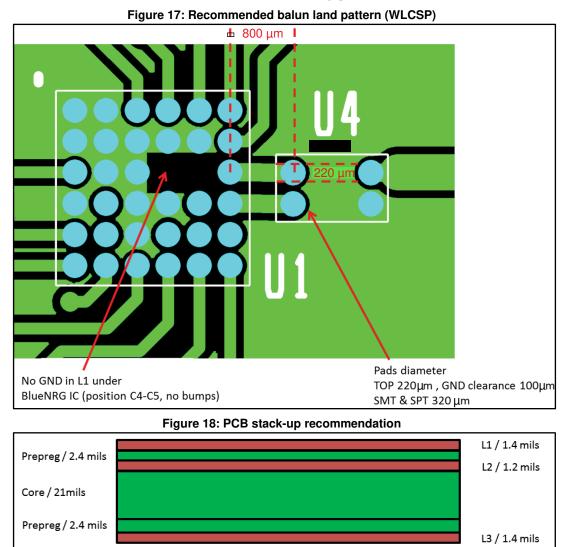
Figure 15: Sensitivity







3 BALF-NRG-01D3 with WLCSP type BlueNRG





3.1 BALF-NRG-01D3 measurements on WLCSP EVB

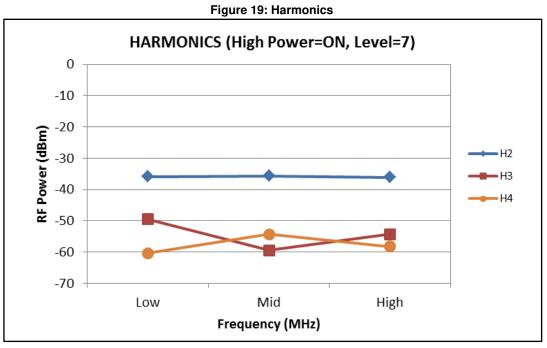
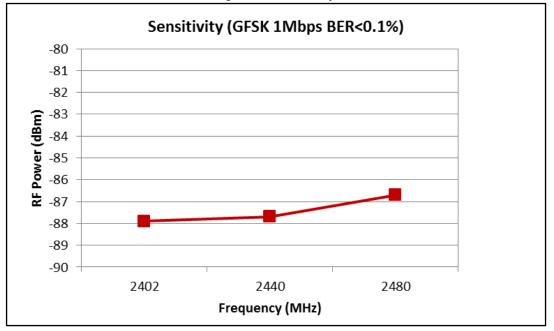
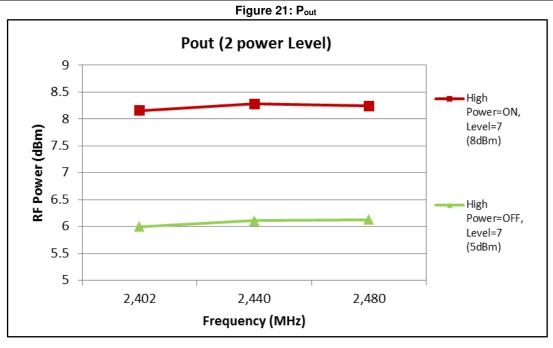


Figure 20: Sensitivity









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Epoxy meets UL94, V0
- Lead-free package

4.1 Flip-Chip 4 bumps package information

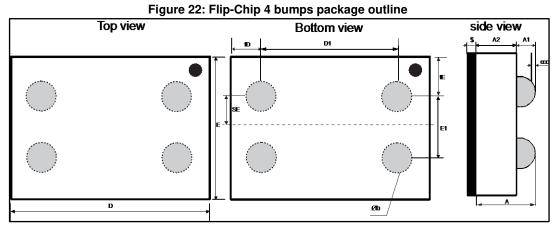


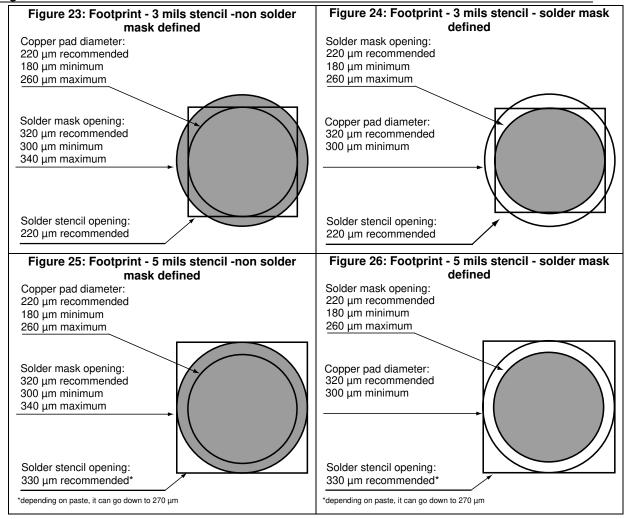
Table 4: Flip-Chip 5 bumps dimensions

Parameter		Dimesions (in mm)		
Farameter	Min.	Тур.	Max.	
A	0.580	0.630	0.680	
A1	0.180	0.205	0.230	
A2	0.380	0.400	0.420	
b	0.230	0.255	0.280	
D	1.375	1.400	1.425	
D1	0.990	1.000	1.010	
E	0.825	0.850	0.875	
E1	0.390	0.400	0.410	
SE		0.200		
fD	0.170	0.200	0.230	
fE	0.195	0.225	0.255	
ccc			0.050	
Ø		0.025		



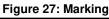
Package information

BALF-NRG-01D3





4.2 Flip-chip 4 bumps packing information



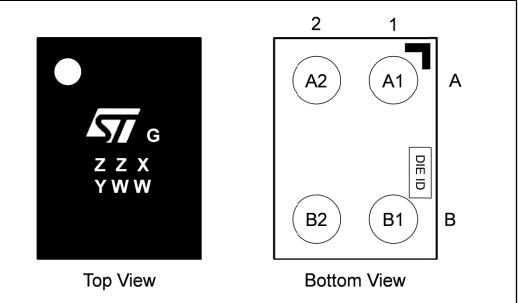
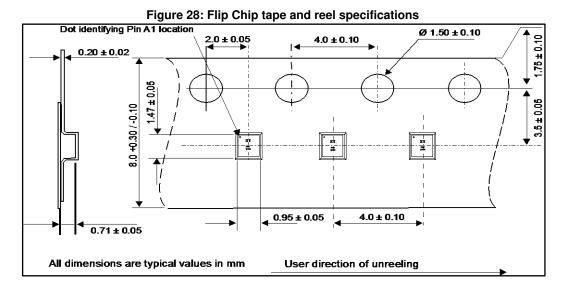


Table 5: Document revision history

Ball	Name	Description	
A1	ANT	Antenna connection	
A2	GND	Ground	
B1	Rx_P	Balun receive positive output	
B2	Rx_N	Balun receive negative output	



More packing information is available in the application note:

AN2348 Flip-Chip: "Package description and recommendations for use"



5 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
BALF-NRG-01D3	SV	Flip-Chip package (4 bumps)	1.35 mg	5000	Tape and reel (7")

6 Revision history

Table 7: Document revision history

Date	Revision	Changes	
17-Jun-2014	1	Initial release.	
17-Jul-2014	2	Updated Figure 13, Figure 17, Figure 22 and package view on cover page. Corrected typo error on Table 2.	
18-Aug-2014	3	Updated title and description in cover page.	
29-Sep-2015	4	Updated Figure 22. Added Figure 25 and Figure 26. Reformatted to current standards.	
04-May-2017	5	Updated Figure 2: "Application schematic with WLCSP type BlueNRG".	



BALF-NRG-01D3

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